onsemi

MOSFET - Power, Single N-Channel

60 V, 6.8 mΩ, 70 A

NVTFS5C670NL

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVTFS5C670NLWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain	Steady	T _C = 25°C	۱ _D	70	А
Current $R_{\theta JC}$ (Notes 1, 2, 3, 4)		T _C = 100°C		49	
Power Dissipation	State	$T_C = 25^{\circ}C$	PD	63	W
$R_{\theta JC}$ (Notes 1, 2, 3)		$T_C = 100^{\circ}C$		31	
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	16	А
Current R _{θJA} (Notes 1, 3, 4)		T _A = 100°C		11	
Power Dissipation		T _A = 25°C	PD	3.2	W
$R_{\theta JA}$ (Notes 1, 3)		T _A = 100°C		1.6	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	440	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	68	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 3.6 A)			E _{AS}	166	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 3)	$R_{\theta JC}$	2.4	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	47	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

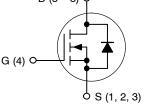
2. Psi (Ψ) is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.

3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

4. Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
60 V	6.8 mΩ @ 10 V	70 A
60 V	10 mΩ @ 4.5 V	70 A



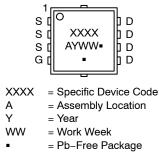




(µ8FL) CASE 511AB

WDFNW8 (µ8FL WF) CASE 515AN

MARKING DIAGRAM



(Note: Microdot may be in either location)

ORDERING INFORMATION

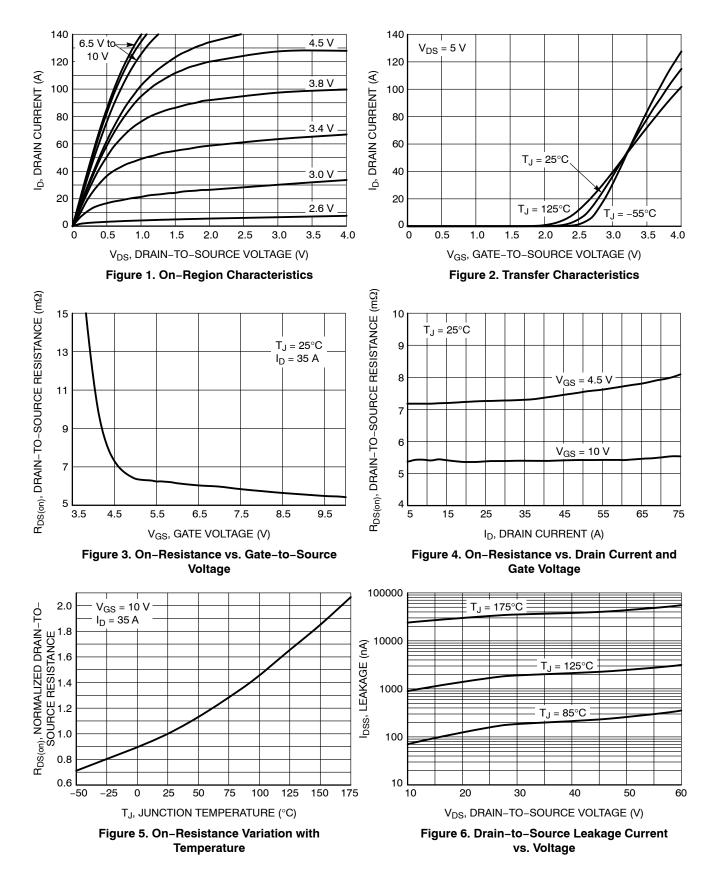
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

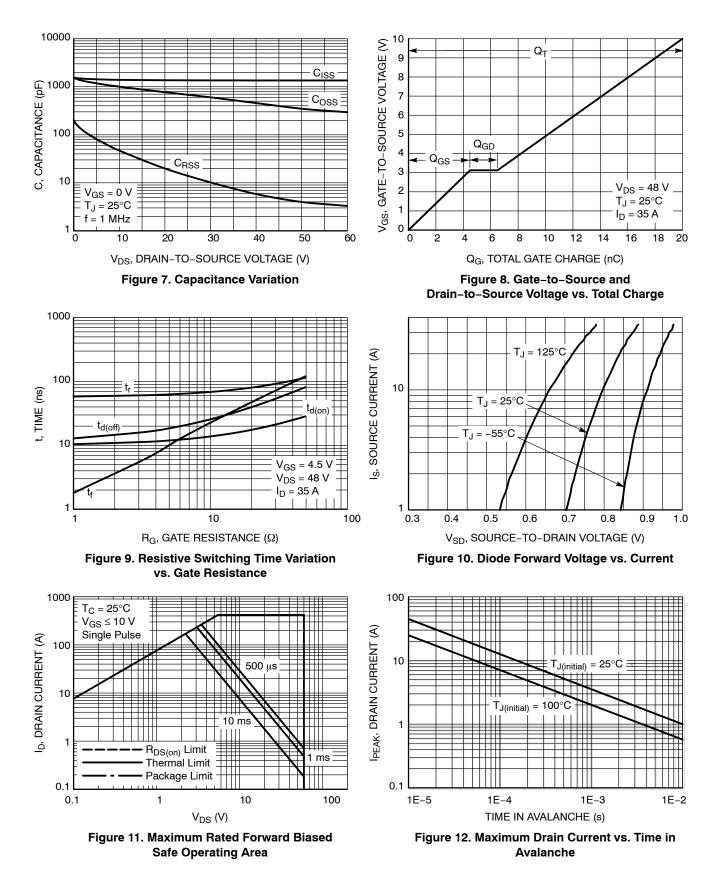
Parameter	Symbol	Test Cond	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				27		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			10	
		V _{DS} = 60 V	T _J = 125°C			250	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 5)				-			-
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 50 μ A		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 35 A		5.6	6.8	1
		V _{GS} = 4.5 V	I _D = 35 A		8.0	10	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _I	_D = 35 A		82		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1400		
Output Capacitance	C _{OSS}				690		pF
Reverse Transfer Capacitance	C _{RSS}				15		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 35 A			9.0		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 35 A			20		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 35 A			2.5		
Gate-to-Source Charge	Q _{GS}				4.5		nC
Gate-to-Drain Charge	Q _{GD}				2.0		
Plateau Voltage	V _{GP}				3.1		V
SWITCHING CHARACTERISTICS (Note 6	;) 	•			-		
Turn–On Delay Time	t _{d(ON)}				11		
Rise Time	tr	V _{GS} = 4.5 V. Vr			60		1
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{DS} = 48 V, I _D = 35 A, R _G = 2.5 Ω			15		- ns
Fall Time	t _f				4		
DRAIN-SOURCE DIODE CHARACTERIS	TICS				•		
Forward Diode Voltage	V _{SD}	$V_{CS} = 0 V_{c}$	$V_{GS} = 0 V$, $T_J = 25^{\circ}C$		0.9	1.2	- v
		$I_{\rm S} = 35 \rm{A}$	T _J = 125°C		0.8		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 35 A			34		
Charge Time	t _a				17		ns
Discharge Time	t _b				17		1
Reverse Recovery Charge	Q _{RR}				19		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



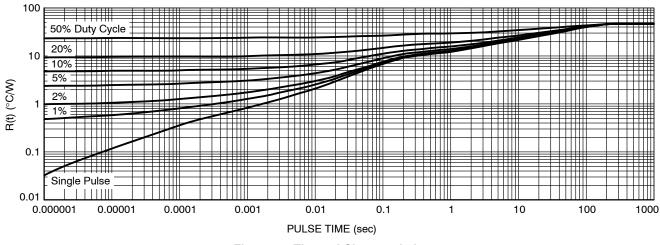


Figure 13	. Thermal	Characteristics
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DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVTFS5C670NLTAG	670L	WDFN8 (Pb-Free)	1500 / Tape & Reel
NVTFS5C670NLWFTAG	70LW	WDFNW8 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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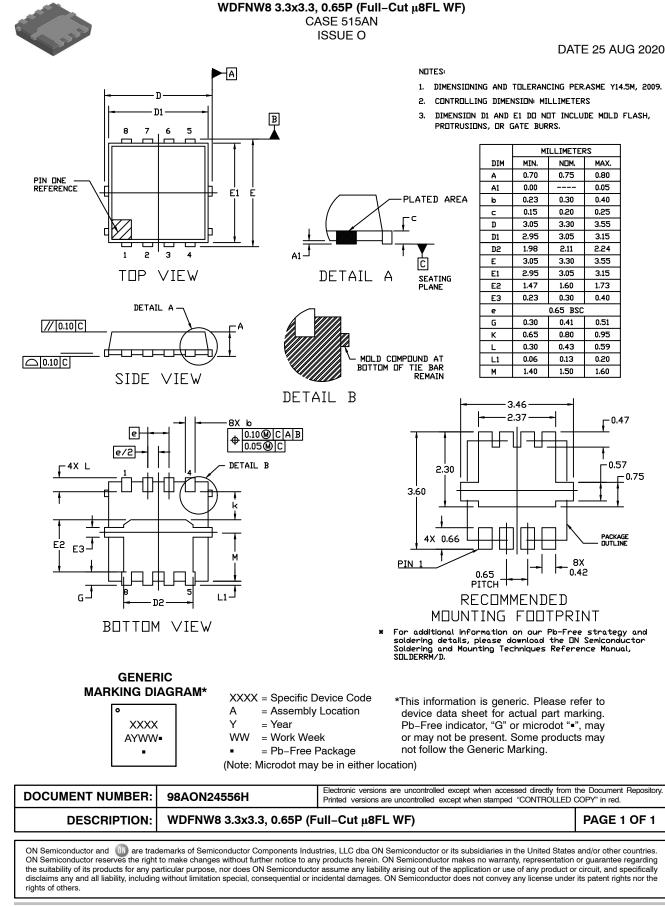
 DESCRIPTION:
 WDFN8 3.3X3.3, 0.65P
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